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Corrosion Protection Properties Afforded by an *In Situ* Electropolymerized Polypyrrole Layer on CuZn

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Adherent polypyrrole films were electropolymerized from a near-neutral sodium oxalate solution at a CuZn electrode. The growth of these films was facilitated by the initial oxidation of the CuZn electrode in the oxalate solution to generate a zinc-containing copper(II) oxalate pseudopassive layer. This layer was sufficiently protective to inhibit further dissolution of the CuZn electrode and sufficiently conductive to enable the electropolymerization of pyrrole at the interface, and the generation of an adherent polypyrrole film. These films exhibited significant corrosion protection properties in acidified and neutral 0.1 mol dm⁻³ NaCl solutions. On continued immersion in these solutions, the polymer films lost some of their corrosion-protection properties, but still remained stable, offering good corrosion protection to the CuZn substrate. (© 2003 The Electrochemical Society. [DOI: 10.1149/1.1618225] All rights reserved.

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There is much interest in the corrosion reactions of Cu-Zn electrodes (brass) and in the development of inhibitors or inhibitor-based coatings suitable for protecting Cu-Zn systems from corroding. Many of the corrosion protection strategies center on the inhibitors employed in the corrosion protection of pure copper. For example, the well-known benzotriazole species, which is an excellent corrosion inhibitor for pure copper, has been used to inhibit the corrosion of Cu-Zn.¹⁻⁶ It has been reported that benzotriazole inhibits the stress corrosion cracking of Cu-30Zn in fluoride solutions¹ and Cu-28Zn in nitrite solutions.² Chadwick and Hashemi³ have detected both copper and zinc in surface films formed on Cu-30Zn in chloride-containing benzotriazole solutions, Gupta et al.,⁴ reported that benzotriazole inhibited corrosion of the copper component, but had little effect on the rate of dezincification of a Cu-30Zn electrode, while Costa et al.5 suggested that the film formed on Cu-30Zn in H₂SO₄-containing benzotriazole solutions consisted of polymeric Cu(I)-benzotriazole units.

Triazole derivatives have also been evaluated as corrosion inhibitors for CuZn. Quraishi *et al.*⁷ have reported the inhibition of dezincification of 70-30 brass by aminoalkyl mercaptotriazoles, while 3-amino-5-heptyl-1,2,4,-triazole has been used as an anodic inhibitor.⁸ Benzimidazoles and substituted benzimidazoles have also been used in the corrosion protection of CuZn.^{9,10}

Although conducting polymers have been used extensively in the corrosion protection of iron and iron-based alloys,¹¹⁻¹⁴ there are, to the best of our knowledge, no reports devoted to the corrosion protection properties of these polymers when applied to copper-zinc alloys. Second, there are no reports in the literature on the electropolymerization of appropriate monomers to generate conducting polymers at a CuZn electrode. Although it is relatively easy to spin-coat conducting polymers at any surface, it is much more difficult to deposit the conducting polymers using *in situ* electropolymerization conditions, as in many cases the metal will dissolve before the electropolymerization approach offers several advantages over other coating technologies, such as spin coating; the main advantage being the ability to form the polymer on irregular-shaped objects.

In this paper, results are presented on the *in situ* electropolymerization of pyrrole at a copper-zinc electrode from a near-neutral oxalate solution to produce a smooth and adherent polypyrrole coating. The corrosion protection properties of this layer are assessed using electrochemical techniques in highly aggressive chloridecontaining solutions.

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Experimental

Test specimens were prepared from Cu37Zn (total impurities <6000 ppm). The electrodes were embedded in epoxy resin in a Teflon holder and electrical contact achieved by means of a copper wire threaded into the base of the metal sample. The exposed surfaces were polished to a 1200 grit finish using SiC paper. They were then cleaned in distilled water and dried under a stream of air.

The electrochemical cell consisted of a three-electrode cell. A saturated calomel electrode (SCE) was used as the reference electrode, and high-density graphite rods were used as the auxiliary electrodes. All potentials quoted are on the SCE scale.

The electrolytes were prepared using analytical grade reagents and distilled water. The electropolymerization solution consisted of 0.1, 0.2, or 0.3 mol dm⁻³ pyrrole added to a 0.125 mol dm⁻³ sodium oxalate solution adjusted to a pH of 7.8. A 0.1 mol dm⁻³ NaCl solution, adjusted to pH values of 3.5 or 7.8, using either NaOH or HCl, was used as the aggressive solution.

Electrochemical experiments were carried out using an EG&G PAR potentiostat, model 263. The electropolymerization was carried out at constant potentials varying from 800 to 1100 mV (SCE). Once the polymers were formed the electrodes were rinsed with distilled water and then immersed in the chloride-containing solutions. Anodic polarization tests were performed by polarizing the electrodes from below the corrosion potential at a scan rate of 0.5 mV s⁻¹ in the anodic direction. Cyclic voltammetry measurements were preformed in the monomer-free solutions at a scan rate of 20 mV s⁻¹, or in 0.1 mol dm⁻³ Na₂SO₄ at 5 mV s⁻¹. Scanning electron micrographs (SEMs) and energy dispersive X-ray (EDX) analyses were recorded on a Hitachi S-4700 cold cathode field emission SEM using a secondary electron detector and at an accelerating voltage of 15 kV. X-ray spectra were obtained using an Oxford Instruments Inca Energy EDX detector attached to the SEM. The samples were gold-coated prior to imaging using an Emitech K550 sputter coater. Fourier transform infrared (FTIR) spectra of the polymers were re-corded between 500 and 4000 cm⁻¹ using a Nicolet 400 D FT spectrometer. The spectra were obtained from compressed pellets of KBr in which powders of the polymer were evenly dispersed.

Results

The *in situ* electropolymerization of pyrrole at a Cu-Zn electrode was attempted using two procedures, deposition by cycling the electrode in the monomer-containing solution and deposition by applying a constant potential to the electrode in the monomer-containing solution. The results obtained using these two methods are shown in Fig. 1 and 2, respectively. The data shown in Fig. 1 were recorded in a 0.2 mol dm⁻³ pyrrole solution by cycling the electrode between -500 and 1000 mV (SCE). The voltammograms are characterized by a low current at potential is increased further, a sharp increase in the anodic current is observed, consistent with the onset of dissolution.

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Figure 1. Cyclic voltammograms recorded for CuZn in a 0.2 mol dm⁻³ pyrrole, 0.125 mol dm⁻³ Na₂C₂O₄, pH 7.8 solution, (• • • •) 2nd cycle, (—) 4th cycle, (— —) 6th cycle, (--) 8th cycle.

A sharp decrease in the anodic current is observed at higher potentials as passivation, or pseudopassivation, of the CuZn electrode occurs. It is seen with successive cycles that the extent of the alloy dissolution event, or activation, is lowered and that the onset of passivation occurs at lower potentials. This procedure of alloy activation followed by alloy repassivation did not lead to the deposition of polypyrrole.

However, uniform adherent polypyrrole layers could be deposited at potentials in the pseudopassive domain. In these experiments, the pyrrole was electropolymerized directly at the CuZn electrode without any prior surface treatment or polarization step. Data showing the electropolymerization of pyrrole in a 0.2 mol dm^{-3} pyrrolecontaining solution as a function of applied potential and at 900 mV (SCE) as a function of the pyrrole concentration are shown in Fig. 2a and b, respectively. Included also in Fig. 2b are data recorded in the monomer-free solution at 900 mV (SCE). It can be seen from these data that the current drops rapidly initially, but then increases to reach a peak value with subsequent decay at a much slower rate. This behavior can be seen more clearly in Fig. 2c, where the currenttime behavior on electropolymerization at 0.8 V (SCE) in a 0.2 mol dm⁻³ pyrrole solution is shown during the first 300 s. In this case, the current drops rapidly during the first 9 s to reach a minimum value, the current then increases at a rate of $1.6 \times 10^{-4} \text{ A s}^{-1}$ to reach a peak value at about 20 s. This is followed by a somewhat slower, 6.5×10^{-5} A s⁻¹, decay in the current for approximately 20 s, and then the current decays more slowly to reach the steadystate values shown in Fig. 2a and b. Although the magnitude of these peak currents, the time period at which they were observed, and the subsequent rates of decay varied somewhat with the applied potential and on the pyrrole concentration, they seem to be connected with the dissolution of the CuZn electrode in the oxalate solution and the formation of a complex oxalate surface. This is evident from the data recorded in the monomer-free solution, where a similar current-time profile can be seen. Further evidence to support this was obtained by depositing polypyrrole at an oxalate-modified CuZn electrode, as opposed to the direct approach used to record the data in Fig. 2. In these experiments, the CuZn electrode was polarized at 900 mV (SCE) in the monomer-free oxalate solution and then pyrrole was added to the solution following a 30 min polarization period. On addition of pyrrole to the solution the current remained constant indicating that the initial oxidation current peaks, Fig. 2, are due to dissolution of the electrode and subsequent formation of a complex oxalate film as opposed to the nucleation of a polypyrrole film.

An interesting trend can be seen on comparing the near steadystate currents, that is the currents measured after approximately 1500 s, Fig. 2a and b. High currents, typically 5 mA cm⁻², are



Figure 2. (a) Potentiostatic current-time plots for CuZn polarized in 0.2 mol dm^{-3} pyrrole in a pH 7.8, 0.125 mol dm^{-3} Na₂C₂O₄ at (---) 1.1 V(SCE); (---) 0.8 V(SCE); (---) 0.7 V(SCE). (b) Potentiostatic current-time plots for CuZn polarized at 0.9 V(SCE) in a pH 7.8, 0.125 mol dm^{-3} Na₂C₂O₄ solution containing pyrrole concentrations of (----) 0, (--) 0.1 (--) 0.2, and (----) 0.3 mol dm^{-3} . (c) Potentiostatic current-time plots for CuZn polarized at 0.8 V in 0.2 mol dm^{-3} pyrrole in a pH 7.8, 0.125 mol dm^{-3} Na₂C₂O₄ solution.

measured at the higher potentials, 1100 mV, and the higher pyrrole concentrations, 0.3 mol dm⁻³. These conditions favor higher rates of polypyrrole formation. However, the steady-state currents recorded in the monomer-free solution, 1.7 mA cm⁻², are higher than those recorded in the solutions containing 0.1 or 0.2 mol dm⁻³ pyrrole, Fig. 2b, conditions favoring a lower rate of polypyrrole formation. This appears to be connected with the fact that the activity of the CuZn electrode depends on the extent of electropolymerization. Under conditions that favor high rates of electropolymerization, the initial electropolymerized layer inhibits further dissolution of the electrode, whereas under conditions that favor low rates of electropolymerization, the CuZn electrode continues to oxidize and dissolve. It is also interesting to point out that these steady-state currents measured in the monomer-free solution indicate limited protective properties of the oxalate layers.



Figure 3. (a) Cyclic voltammograms recorded for pure zinc in a 0.125 mol $dm^{-3} Na_2C_2O_4$, pH 7.8 solution, (----) 1st cycle, (----) 2nd cycle, and (----) 3rd cycle. (b) Cyclic voltammograms recorded for pure copper in a 0.125 mol $dm^{-3} Na_2C_2O_4$, pH 7.8 solution, (····) 1st cycle (forward scan), (---) 1st cycle (reverse scan), and (----) 10th cycle (forward scan), and (-----) 10th cycle (reverse scan).

In order to obtain more detailed information on the significance of the initial oxalate pseudopassive layer, experiments were carried out on the electrochemical behavior of pure Zn and pure Cu in this oxalate solution. Cyclic voltammograms showing the electrochemical activity of pure Zn and Cu cycled between the potential limits of -500 and 1000 mV (SCE) in the monomer-free oxalate solution are shown in Fig. 3a and b, respectively. The electrochemical activity of Zn is very dependent on the cycle number. Dissolution of zinc can be seen clearly in the first cycle, with dissolution commencing at -160 mV (SCE) and increasing until potentials in the region of 750 mV (SCE) are reached. Dissolution can also be seen during the reverse scan. However much lower anodic currents are seen in the second and third cycles. This suggests the formation of a Zn-oxide or oxalate film during the first cycle that protects, to some extent, the zinc substrate. However, it was not possible to form polypyrrole at this zinc electrode, which suggests that the oxidized zinc layer is too insulating to enable formation of a polypyrrole film. The cyclic voltammograms recorded for pure Cu, Figure 3b show also that the electrochemical activity of pure Cu is dependent on the cycle number. Dissolution of copper begins at -180 mV (SCE), a peak is seen at 125 mV (SCE) which is consistent with the formation of Cu(I) oxide. At higher potentials, 300 mV (SCE), more intense dissolution is seen. It is unlikely under these conditions that the Cu(II) oxide is formed, or if it is formed, that it remains stable. The subsequent peaks at 580 and 680 mV (SCE) appear to be connected with the formation of Cu(II) oxalates, with the likely oxalates being Cu(Ox) and $Cu(Ox)_{2}^{2-}$, where Ox represents the oxalate species. The electrochemical activity is very different with repetitive cycling, as be seen by comparing the data recorded for the first and tenth cycles. The Cu(II) oxalate peaks are shifted to significantly higher potentials in the forward scan of the tenth cycle. The current remains high during the reverse cycle until the potential drops to about 200 mV (SCE).

There are a number of reports in the literature which show that iron oxalate complexes can be transformed into iron oxides, for example, in a recent study by Nguyen et al.,15 on the electrodeposition of polypyrrole coatings on an iron substrate, it is proposed that a three-dimensional iron oxide is formed due to the low solubility of the Fe(III) oxalate complex. However, there is very little evidence to support such an oxide-transformation step in these experiments. First, the Cu(II) oxalate complex species have a considerably lower solubility than either the iron(II) or iron(III) oxalates. The Fe(III) oxalate is known to be highly soluble, while the solubility of the Fe(II) oxalate is 1.5×10^{-3} mol dm⁻³, but the solubility of the Cu(II) oxalate is $1.5 \times 10^{-4} \text{ mol dm}^{-3}$; a significantly lower value.16 Accordingly, it is unlikely that this salt is sufficiently soluble to enable the formation of the corresponding oxide. Second, Cu(I) and Cu(II) oxides can be easily observed as reduction peaks in cyclic voltammetry,¹⁷ corresponding to the equilibria described in Eq. 1 and 2

$$2Cu(OH)_2 + 2e^- \rightarrow Cu_2O + 2OH^- + H_2O$$
 [1]

$$Cu_2O + 2H^+ + 2e^- \rightarrow 2Cu + 2H_2O$$
 [2]

However, there was no evidence of such peaks in these experiments, even on polarizing the electrodes to reduction potentials in the region of -1.0 V (SCE).

Although this system is complex, with the generation of Cu(II) oxalate species, it was possible to form polypyrrole at this copperoxalate layer,¹⁸ indicating that the copper-oxalate layer is sufficiently conducting to enable the polymerization of pyrrole at the interface, unlike that observed for pure Zn.

In Fig. 4a an SEM micrograph of the polypyrrole film deposited on CuZn is shown. These polymers were formed in a 0.2 mol dm⁻¹ pyrrole solution at 900 mV(SCE) and allowed to dehydrate over several days exposure to air at 25°C. These data show clearly that the polymer is homogeneous and is crack and defect-free despite being dehydrated over an extended period, which indicates that the metal-polymer system is stable to ageing. The micrograph shows the characteristic microspheroidal grains or aggregates of polypyrrole, with sizes up to 5 µm. It is also interesting to note that the deposition of the polypyrrole appears to take place along polishing lines on the alloy surface, as evident from the ridge-like diagonal traces in the micrograph. The X-ray analysis of the area shown in Fig. 4a is provided in Fig. 4b. This shows the presence of carbon from the polypyrrole, but also copper and zinc. Although some of the copper and zinc signal obviously originates from the metal substrate, there also appears to be some copper and zinc trapped within the polymer. Evidence in support of this could be obtained by sampling different areas of the surface. In particular, the light-colored particles had higher copper and zinc counts suggesting higher concentrations of these species at such points. This suggests that copper and zinc oxalate species are present within the polymer structure.

The results of an FTIR analysis of the polypyrrole coating formed in a 0.2 mol dm⁻³ pyrrole solution at 900 mV (SCE) are presented in Table I. Here the wavenumber of the bands observed and the assignments of these bands, based on literature reports, ¹⁹⁻²¹ are presented. Two important conclusions can be made. First, these bands are consistent with literature reports and can be assigned to polypyrrole. For example, the bands centered at 1088 cm⁻¹ correspond to the C-H and N-H in-plane ring deformation, while the absorption at 802 cm⁻¹ corresponds to the C-H out-of-plane ring deformation. The characteristic C-C stretching vibration of the ring, centered at 1550 cm⁻¹, is not seen due to the overlapping of this signal with the strong absorption at 1620 cm⁻¹ of the oxalate counter anion. The position of this latter band was confirmed by recording the FTIR spectra of oxalate. Second, the presence of the doping oxalate can be clearly identified, showing, as expected, that these polymers are doped with oxalate anions.



Figure 4. (a) SEM micrographs of the polypyrrole coated CuZn electrode. (b) X-ray analysis of the polypyrrole-coated electrode.

The data in Fig. 5a show the electrochemical behavior of the polypyrrole-coated CuZn electrode in 0.1 mol dm⁻³ Na₂SO₄. Again, the polymer was deposited at 900 mV (SCE) from a 0.2 mol dm⁻³ pyrrole solution. These data were recorded at a scan rate of 5 mV s⁻¹. Before cyclic polarization, the sample was polarized at 0.4 V (SCE) to enable oxidation of the polymer. These data are typical of pure polypyrrole cycled in a sulfate solution.²² Indeed similar data were recorded for polypyrrole deposited at pure platinum from a 1.0 mol dm⁻³ H₂SO₄ solution. A reduction peak centered at -625 mV (SCE) and an oxidation peak at -195 mV (SCE) is observed, showing that the polypyrrole deposited at CuZn using the relatively high potential of 900 mV (SCE) exhibits typical redox activity.

Similar data recorded for the uncoated CuZn electrode are presented in Fig. 5b. For the sake of comparison with the data presented in Fig. 1 these were recorded in the monomer-free solution. Low currents are measured at potentials between -500 and -150 mV

Table I. FTIR analysis of polypyrrole deposited at 900 mV (SCE) from a 0.2 mol dm^{-3} pyrrole solution.

Wavenumber (cm ⁻¹)	Assignment
1624 (s) (b) ^a	Oxalate counter anion
1258 (s)	C-O stretch from oxalate counter anion
1472 (w)	C-N stretching vibration of the ring
1088 (s)	C-H and N-H in-plane deformation of ring
1030 (s)	C-H in-plane deformation of ring
802 (s)	C-H out of plane ring deformation
680 (w)	C-C out-of-plane ring deformation or C-H
	rocking

a s = strong, b = broad, w = weak.



Figure 5. (a) Cyclic voltammograms recorded for polypyrrole-coated CuZn in a 0.1 mol dm⁻³ Na₂SO₄ solution at a scan rate of 5 mV s⁻¹. (b) Cyclic voltammograms recorded for uncoated CuZn in 0.125 mol dm⁻³ Na₂C₂O₄, pH 7.8, (—) 2nd cycle, (---) 4th cycle, (——) 6th cycle, (— —) 8th cycle.

(SCE), but at potentials higher than -100 mV (SCE) an abrupt increase in the anodic current is observed indicating the activation and anodic dissolution of the electrode. At potentials higher than approximately 200 mV (SCE) a rapid decrease in the anodic current is observed, consistent with the formation of a pseudopassive region. The electrodes appear to become more stable with successive cycling; the charge passed during the forward scan decreases with increasing cycle number. For example, the charges passed during the second, fourth, sixth, and eight cycles were typically 0.266, 0.246, 0.130, and 0.102 C cm⁻², respectively. It is interesting to point out that these voltammograms are similar to those presented in Fig. 1, which show that the electrochemical behavior of CuZn in the pyrrole-containing solution, under these cyclic conditions, is dominated by the electrochemical response of the CuZn-oxalate system. However, once the polymers are formed there is no evidence of any metal dissolution or repassivation, Fig. 5a. This indicates that the deposited polypyrrole coatings are stable and protective.

In order to assess the corrosion protection properties of the coated electrodes polarization plots were recorded for the coated and uncoated electrodes in the aggressive test solutions and compared. Representative plots showing the anodic polarization behavior of the coated and uncoated CuZn electrode in a 0.1 mol dm⁻³ NaCl solution adjusted to a pH of 3.5 and 7.8 are shown in Fig. 6a and b, respectively. For comparative purposes, the anodic polarization behavior of the oxalate-coated electrode in the acidified chloride solution is shown also in Fig. 6a. The anodic polarization behavior of CuZn and the oxalate-coated surface in the acidified solution is consistent with active dissolution. The anodic current increases steadily at potentials beyond the corrosion potential, which lies at -130 mV



Figure 6. (a) Anodic polarization plots recorded in a pH 3.5, 0.1 mol dm⁻³ NaCl solution for (—) uncoated CuZn, (••••) polypyrrole-coated CuZn, and (– –) oxalate-coated CuZn. (b) Anodic polarization plots recorded in a pH 7.8, 0.1 mol dm⁻³ NaCl solution for (—) uncoated CuZn and (••••) polypyrrole-coated CuZn.

(SCE) for the uncoated and -190 mV (SCE) for the oxalate-coated surface, to reach currents on the milliampere scale at approximately -30 mV (SCE). The polarization behavior of the polymer-coated CuZn electrode is significantly different, representing a much more corrosion-resistant system. The corrosion potential lies at a much more noble potential, 60 mV (SCE), and the current recorded during polarization of the electrode to high anodic potentials remains low, increasing slightly with increasing potential, until potentials exceeding 500 mV (SCE) are reached. A more rapid increase in the anodic current is observed at 520 mV (SCE) indicating dissolution of the underlying substrate. Similar behavior is seen in the near-neutral solution; breakdown of the polymer-coated electrode does not occur until potentials exceeding 540 mV (SCE) are reached. Dissolution of the substrate was confirmed by adding the indicator, Erichrome Black T, to the test solution. This indicator, which is sensitive to the presence of zinc cations, changed color from its characteristic blue color to a pink-violet color, characteristic of the presence of Zn^{2+} , at potentials just anodic to the breakdown potential. However, the copper-sensitive indicator, Murexide, did not undergo any color change at the breakdown potential indicating that these breakdown events involve, mainly, the dissolution of the zinc component. The currents recorded in the acidified solution are slightly higher than those recorded in the pH 7.8, solution which may be connected to the conducting properties of the polypyrrole layer, being doped to a greater extent in the acidified solution. It is also important to point out that the oxalate coating offers no corrosion protection properties.

The open-circuit potential adopted by the uncoated and polymercoated CuZn electrode as a function of time in the pH 3.5 and 7.8 chloride-containing solutions are shown in Fig. 7a and b respectively. The open-circuit potential of the uncoated electrodes reaches near-constant values after a short immersion period, approximately



Figure 7. (a) Open-circuit potential-time plots recorded in a pH 3.5, 0.1 mol dm^{-3} NaCl solution for (—) uncoated CuZn and (—) polypyrrole-coated CuZn. (b) Open-circuit potential-time plots recorded in a pH 7.8, 0.1 mol dm^{-3} NaCl solution for (—) uncoated CuZn and (—) polypyrrole-coated CuZn.

 6×10^3 s. The open-circuit potential of the polymer-coated electrodes decays slowly and reaches near steady-state values after approximately 2×10^4 s. At this point the differences between the open-circuit potentials of the coated and uncoated electrodes are approximately 60 mV in the pH 7.8 solution and approximately 34 mV in the pH 3.5 solution. The anodic polarization behaviors of the coated and uncoated electrodes following the 14 h immersion period in the pH 7.8 solution are shown in Fig. 8. Again, the more superior



Figure 8. Anodic polarization plots recorded in a pH 7.8, 0.1 mol dm⁻³ NaCl solution for (——) uncoated CuZn and (· · · ·) polypyrrole-coated CuZn following a 14 h immersion period.

corrosion resistance of the coated CuZn electrode can be seen here, with the difference between the breakdown potentials of the coated and uncoated electrodes, being of the order of 300 mV (SCE). However, it can be seen on comparing these data to those presented in Fig. 6b that the coated surface loses some of its corrosion protection properties on prolonged immersion in the halide solution.

Discussion

It can be seen from the results presented that adherent and homogeneous polypyrrole coatings can be deposited onto CuZn in the presence of oxalate anions at near-neutral pH values. These layers exhibit significant corrosion protection properties in highly aggressive chloride-containing solutions. The ease of formation of the polypyrrole layer at CuZn appears to be connected with the fact that a pseudopassive-like layer, or film, forms on the CuZn electrode under the electropolymerization conditions employed. This layer inhibits dissolution of the alloy and facilitates the formation of polypyrrole. It is interesting to note that these polypyrrole layers could not be formed at the CuZn electrode from other media, such as HCl or H₂SO₄. Similar effects have been reported for the deposition of conducting polyaniline on iron or steel.¹¹⁻¹⁴ For example, the electrosynthesis of adherent polyaniline films on iron has been reported in oxalic and phosphoric acid media, but not in the presence of hydrochloric acid. This has been attributed to the formation of iron oxalate or iron phosphate layers on the metal surface, which are sufficiently protective to decrease the rate of iron dissolution but not sufficiently insulating to inhibit the electropolymerization process. Indeed, Bernard *et al.*¹¹ have shown that the corrosion protection properties of the final polyaniline film is dependent on the nature of this passive layer.

This passive layer that forms in the neutral oxalate solution is complex, consisting of copper and zinc species. Morales *et al.*^{23,24} have shown, using XPS, that the passive layer formed on various brasses in a pH 9 solution consists of a complex ZnO·H₂O/Cu₂O-CuO layer. The ZnO electroformation results in a dezincification process so that a thin copper-rich layer resides at the metal/oxide interface. The oxidation of zinc in this oxalate solution can be seen clearly from the first cycle in Fig. 3a, where the anodic current is seen to increase with increasing potential. However, on subsequent cycles, low anodic currents are measured being consistent with the precipitation of the oxalate complex, ZnC_2O_4 , which is sparingly soluble with a pK_s of 7.9²⁵ (where K_s refers to the solubility product). Taking the oxalate concentration of 0.125 mol dm⁻³ and using the pK_s value, it is seen that the solubility product is exceeded at a Zn^{2+} concentration of 1 \times 10⁻⁷ mol dm⁻³. However, the amount of Zn²⁺ calculated from the first cycle depicted in Fig. 3a is 1.5×10^{-6} mol, which shows that under these conditions the solubility product is exceeded at the surface, and accordingly ZnC₂O₄ is likely to form at the surface. The competing zinc oxide/hydroxide reaction may occur to some extent, but the pH of 7.8, is not sufficiently alkaline for this reaction to dominate the chemistry. Indeed, Macdonald et al.26 have concluded that the major zinc species at a pH of 7.8 are the soluble Zn^{2+} and $Zn(OH)^{+}$ species. The concentration of the passivating layer, Zn(OH)₂, is essentially zero under these neutral pH conditions.

There is also clear evidence for the formation of copper oxalate complex species. For example, on comparing the data for pure zinc, pure copper, and copper-zinc, in Fig. 3a, b and 5b, it is clear that the data recorded for the copper-zinc electrode shows evidence of zinc oxidation and copper-oxalate complexation. In the case of the CuZn system, the anodic currents detected at low potentials, for example -200 mV (SCE) are consistent with the oxidation of zinc, whereas the anodic currents measured at the higher potentials, for example, 0.5 to 1.0 V (SCE) are similar to the second-cycle data recorded for the Cu system, indicating oxidation of the copper component and the formation of copper oxalate species. Evidence to support this idea of a mixed zinc and copper oxalate layer can be found from the

fact that the electrochemical activity of the CuZn electrode is very different with successive cycling to that obtained for the pure Zn system, where a highly stable state is obtained on the second cycle. Also, the fact that pyrrole could not be electropolymerized at the zinc electrode is further proof for the presence of copper oxalate in the film formed on CuZn.

It is well known that oxalate anions form stable complexes with copper cations. In particular, oxalate anions (Ox^{2^-}) form complexes with Cu^{2^+} to generate copper oxalate complexes with a 1:1 and 1:2 stoichiometry.

$$Cu^{2+} + Ox^{2-} \rightleftharpoons Cu(Ox)$$
 [3]

$$\operatorname{Cu}^{2^+} + 2\operatorname{Ox}^{2^-} \rightleftharpoons [\operatorname{Cu}(\operatorname{Ox})_2]^{2^-}$$
[4]

In addition, depending on the acidity of the medium, the 1:1 oxalate complex can be protonated in accordance with Eq. 5

$$Cu(Ox) + H^+ \rightleftharpoons [HCu(Ox)]^+$$
 [5]

Zouaoui *et al.*²⁷ have shown that $[Cu(Ox)_2]^{2^-}$ is the more stable complex in the pH range 3-11 for a solution of Cu²⁺ and Ox²⁻. Thus, the CuZn oxalate layer is likely to contain copper as the anionic $[Cu(Ox)_2]^{2^-}$ species. The inclusion of this complex in the initial layer is sufficient to reduce the insulating character of the pure zinc complex layer enabling the electropolymerization of pyrrole. There are also reports in the literature which show that the presence of dissolved Cu²⁺ species increases the polymer yield during the synthesis of conducting polymers, such as polypyrrole.^{28,29} For example, Miller *et al.*²⁸ in studying the reaction of pyrrole and thiophene monomers with copper- or nickel-exchanged mordenite found that polymerization occurred only with the copper-exchanged mordenite. This was attributed to the better oxidizing power of the Cu(II) cation. Thus, the presence of dissolved Cu²⁺ at the CuZn electrode may also be connected with the ease of electropolymerization at the CuZn electrode.

It can be seen from the data presented in Figs. 6, 7, and 8 that the polypyrrole-coated CuZn electrodes exhibit significant corrosion protection properties in both an acidified and neutral chloridecontaining solution, particularly following formation. There is a clear ennoblement in the open-circuit potentials, Fig. 7a and b, an effect that is also evident with polyaniline-coated iron electrodes, and which has been attributed generally to an anodic protection mechanism.¹³ It is interesting to compare the open-circuit potentialtime behavior of these polypyrrole-coated CuZn electrodes with those of polyaniline-coated iron.¹¹ Both systems behave similarly during the early stages of immersion. The open-circuit potentials of both polymer-modified electrodes fall slowly until a near-steady state value is reached. However, in the case of the polyaniline-iron system the potential drops rapidly at some extended time, typically minutes to hours, to reach values near the open-circuit potential of the uncoated iron, signifying loss of the corrosion protection properties. This is not seen with the CuZn system; even after eight days of immersion, the potentials remain at the early steady-state values. Indeed, the ability of the polymer to protect the underlying alloy following 14 h immersion in a highly aggressive chloride solution can be seen clearly in Fig. 8. This apparent stability of the polypyrrole layer on the CuZn electrode may be connected to recent reports which show that Cu(I) can be used to enhance the conductivity and stability of polypyrrole.³⁰ This has been attributed to electron transfer between copper and the N⁺ of polypyrrole to form a stable Cu-polypyrrole complex, thus preventing nucleophilic attack on the positively charged nitrogen, for example, by H₂O.

Conclusions

Pyrrole was successfully electropolymerized at a CuZn electrode in a near-neutral sodium oxalate solution to generate a homogeneous and adherent polypyrrole film. Dissolution of the CuZn electrode was inhibited through the formation of a pseudopassive layer comprising a zinc(II) and copper(II) oxalate species, at which the polypyrrole film nucleated. These films exhibited significant corrosion protection properties in acidified and neutral 0.1 mol dm⁻³ NaCl solutions.

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